

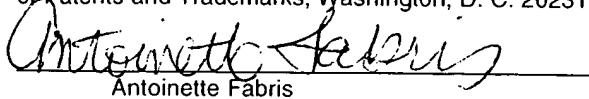
BEST AVAILABLE COPY

08-31-01

2154

Express Mail mailing label no. EL556464555US  
Date of Deposit: August 29, 2001

I hereby certify that this paper or fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to the Commissioner of Patents and Trademarks, Washington, D. C. 20231.

  
Antoinette Fabris

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of: Chaiken et al. O I P E Docket No.: AGLE0027

Serial No. : 09/909,774

AUG 29 2001

Art Unit: 2154

Filed: July 19, 2001

Examiner: Unassigned

Title: MULTI-DIMENSIONAL INTEGRATED CIRCUIT CONNECTION NETWORK  
USING LDT

Assistant Commissioner for Patents

Washington, DC 20231

**Transmittal of Formal Drawings**

RECEIVED  
SEP 04 2001  
Technology Center 2100

Enclosed for the above-referenced application are the following:

1. 3 Sheets of Formal Drawings (Figs. 1-4);
2. Information Disclosure Form
3. Form 1449
4. Cited References
5. Return Postcard.

The Commissioner is authorized to charge any additional fees, or credit any overpayments, to Deposit Account No. 07-1445 (Order No. AGLE0027). A copy is enclosed for this purpose.

Respectfully submitted,



Michael A. Glenn  
Reg. No. 30,176

Customer No. 22862

RECEIVED  
JAN 21 2002  
TC 2100